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	Specification
Part	
Number:	
Version:	
Date:	



design • manufacture • supply

Midas Displays OLED Part Number System

	1	2	3	4	5	6	7	8	9	10
1	=	MCO:		Midas Disp	lays OLED					

B: COB (Chip on Board) **T**: TAB (Taped Automated Bonding)

3 = No of dots: (e.g. 240064 = 240 x 64 dots) (e.g. 2	21605 = 2 x 16 5mm C.H.)
--	--------------------------

$$4 =$$
 Series A to Z

8	=	Colour:	Y: Yellow	W: White	B: Blue	R: Red	G: Green	RGB: Full Colour

9 = Interface: P: Parallel I: I ² C S: SPI M: Multi	
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10 = **Voltage Variant:** e.g. **3** = 3v

MCO

2

В

Blank:

21605

F/Displays/Midas Brand/Midas NEW OLED Part Number System 18 June 2013 2011.doc $\,$

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1. Revision History

DATE	VERSION	REVISED PAGE NO.	Note
2012/11/28	1		First issue

2. General Specification

The Features is described as follow:

■ Module dimension: 122.0 x 44.0 x 10.0 (max.) mm³

■ View area: 99.0 x 24.0 mm²

Active area: 91.14 x 18.98 mm²

■ Number of dots: 16 Character x 2 Line

■ Pixel size: 0.90 x 1.06 mm²

■ Pixel pitch: 0.96 x 1.12 mm2

■ Character size: 4.74 x 8.90 mm2

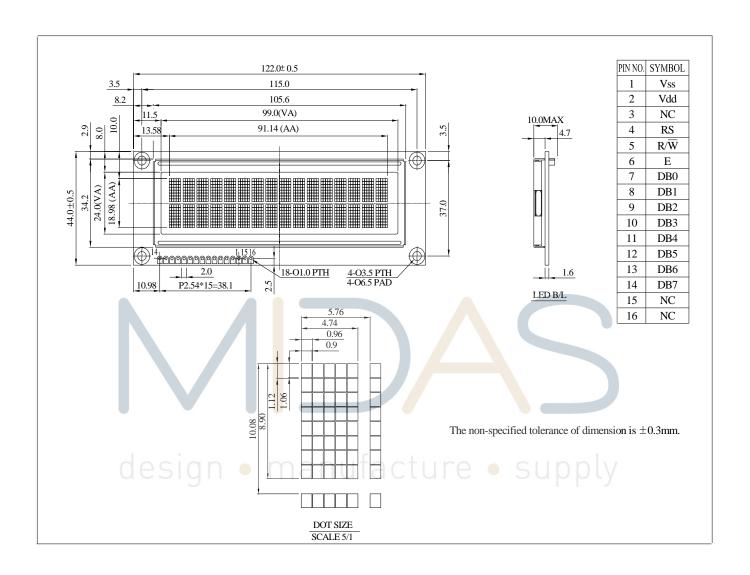
■ Character pitch: 5.73 x 10.08 mm2

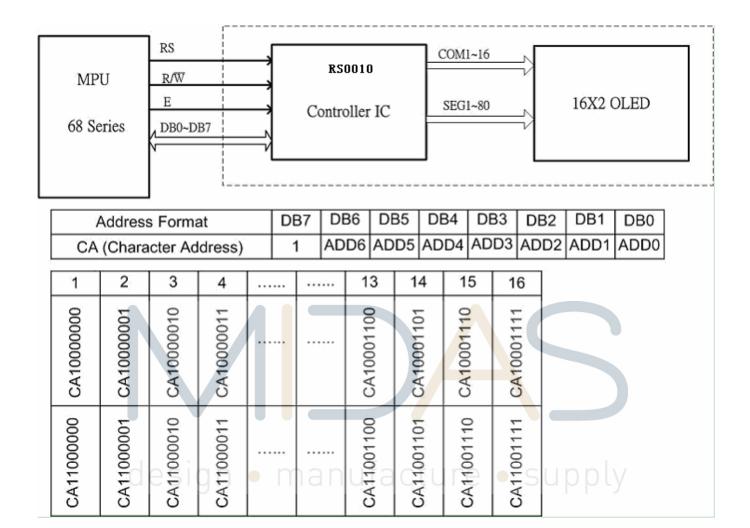
■ Duty: 1/16

Emitting Color: White

4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	VSS	0V	Ground
2	VDD	5.0V	Supply Voltage for logic
3	NC	_	
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	E	H,H→L	Chip enable signal
7	DB0	H/L	Data bit 0
8	DB1	H/L	Data bit 1
9	DB2	H/L	Data bit 2
10	DB3	H/L	Data bit 3
11	DB4	H/L	Data bit 4
12	DB5	H/L	Data bit 5
13	DB6	H/L	Data bit 6
14	DB7	H/L	Data bit 7
15	NC	ian	manufacture • sunnly
16	NC	1911	manacare - supply





Item	Symbol	Min	Max	Unit	Notes
Operating Temperature	T _{OP}	-40	+80	$^{\circ}\!\mathbb{C}$	
Storage Temperature	T _{ST}	-40	+80	$^{\circ}\! \mathbb{C}$	
Input Voltage	Vı	-0.3	VDD	V	
Supply Voltage For Logic	VDD-V _{SS}	-0.3	5.3	V	

7. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	VDD-VSS		3.0	5.0	5.3	V
Input High Volt.	VIH	_	0.9		VDD	V
mpat riight void	,		VDD		,55	v
Input Low Volt.	VIL		GND		0.1VDD	V
Output High Volt.	VOH	IOH=-0.5mA	0.8	_	VDD	V
docian	• man	ufactu	VDD	CIID	volv	·
Output Low Volt.	VOL	IOL=0.5mA	GND	Sup	0.2 VDD	V
Supply Current	IDD	VDD=5V	_	57	_	mA
CIEx(White)		x,y(CIE1931)	0.24	0.28	0.32	
CIEy(White)		x,y(CIE1931)	0.28	0.32	0.36	

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ		160			deg
View Angle	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	_
Daarana Tira	T rise	_		10		μs
Response Time	T fall	_		10		μs
Supply Voltage For Log	ic 5V	With polarizer		60		Nits
50% CheckBoard Brigh	tness	285mW(5V*57mA)				Note1
Supply Voltage For Log	ic 3V	With polarizer		35		nits
50% CheckBoard Brigh	tness					

Notes: 1.When random texts pattern is running, averagely, at any instance, about 1/2 of pixels will be on.

2. You can to use the display off mode to make long life.

9. OLED Lifetime manufacture supply

ITEM	Conditions	Тур	Remark
Operating Life Time	Ta=25°C /Initial 50% checkboard brightness 60nits	50,000 Hrs	Note

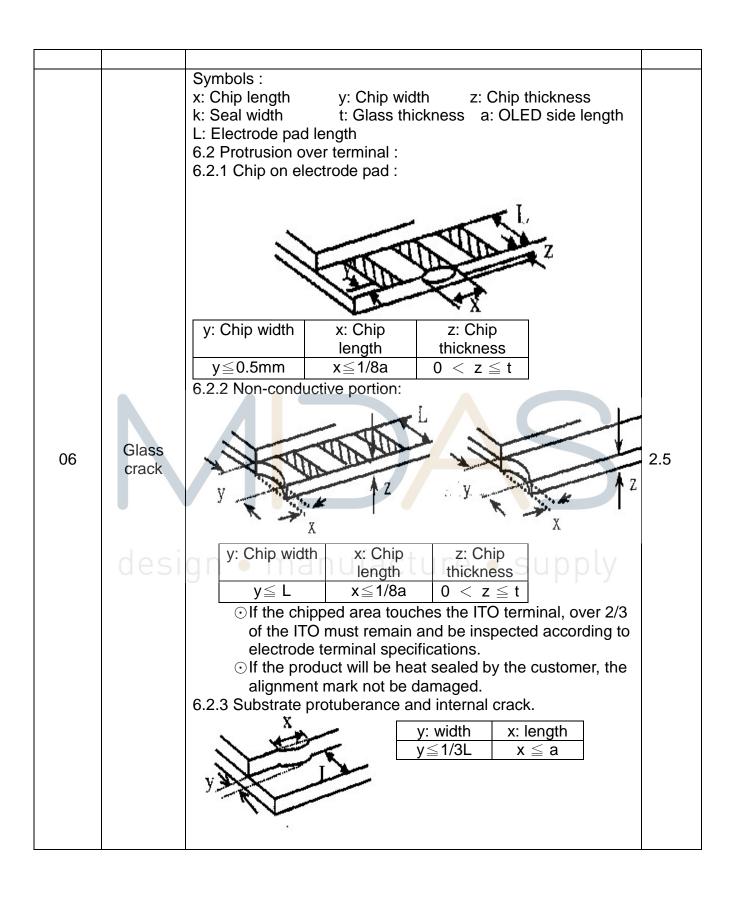
Notes:

- 1. Simulation pattern for operation test: interchanging with 50% checkboard. The brightness decay does not exceed 50%
- 2. You can use the display off mode to make long life.
- 3. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80℃ 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240 <mark>hrs</mark>	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min 1 cycle	-40°C/80°C 100 cycles	
Mechanical Tes	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hrs	supply
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave 11 msedc 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	
	L	ı	

01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 Viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 			0.65	
02	Black or bright spots on OLED (display only)	 2.1 Bright and black spots on display ≤0.25mm, no more than three Bright or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 			2.5	
03	Black spots, bright spots, contaminatio n	3.1 Round type : As following drawing Φ=(x+y)/2			2.5	
	(non-display)	3.2 Line type : (As fo	Length L≦3.0 L≦2.5	wing) Width W≦0.02 0.02 < W≦0.03 0.03 < W≦0.05 0.05 < W	Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size Φ $ Φ \le 0.20 $ $ 0.20 < Φ \le 0.50 $ $ 0.50 < Φ \le 1.00 $ $ 1.00 < Φ $ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

05	Scratche s	Follow NO.3 black spots, bright spots, contamination	
06		Symbols Define: x: Chip length x: Chip length x: Chip length x: Chip length x: Chip width x: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels: z: Chip thickness Z≤1/2t Not over viewing area 1/2t < z≤2t Not exceed 1/3k olf there are 2 or more chips, x is total length of each chip thickness z≤1/2t Not over viewing area 1/2t < z≤2t Not exceed 1/3k x: Chip length x≤1/8a x≤1/8a x≤1/8a x≤1/8a x≤1/8a x≤1/8a x≤1/8a x≤1/8a	2.5
		⊙ If there are 2 or more chips, x is the total length of each chip.	

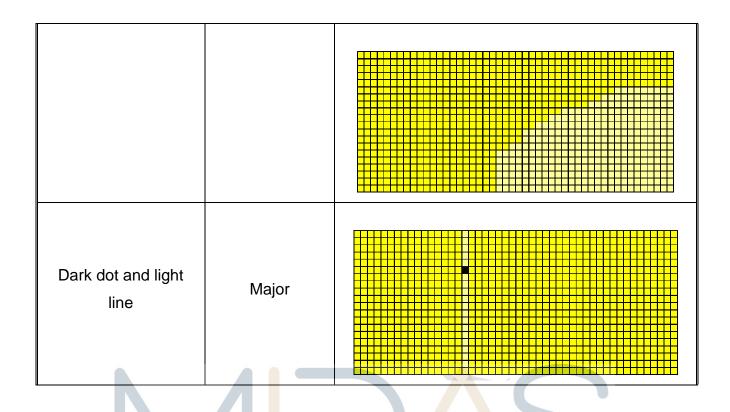


07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Bezel	8.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.8.2 Bezel must comply with job specifications.	2.5 0.65
9	PCB COB	 9.1 COB seal may not have pinholes larger than 0.2mm or contamination. 9.2 COB seal surface may not have pinholes through to the IC. 9.3 The height of the COB should not exceed the height indicated in the assembly diagram. 9.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 9.5 No oxidation or contamination PCB terminals. 9.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 9.7 The jumper on the PCB should conform to the product characteristic chart. 9.8 If solder gets on bezel tab pads, zebra pad or screw hold pad, make sure it is smoothed down. 9.9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5
10	Soldering	 10.1 No un-melted solder paste may be present on the PCB. 10.2 No cold solder joints, missing solder connections, oxidation or icicle. 10.3 No residue or solder balls on PCB. 10.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

		11.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		11.2 No cracks on interface pin (OLB) of TCP.	0.65
		11.3 No contamination, solder residue or solder balls on	2.5
		product.	2.5
		11.4 The IC on the TCP may not be damaged, circuits. 11.5 The uppermost edge of the protective strip on the	2.5
11	General	interface pin must be present or look as if it causes the interface pin to sever.	2.5
	appearance	11.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		11.7 Sealant on top of the ITO circuit has not hardened.	0.65
		11.8 Pin type must match type in specification sheet.	0.65
		11.9 OLED pin loose or missing pins.	0.65
		11.10 Product packaging must the same as specified on	
		packaging specification sheet.	0.65
		11.11 Product dimension and structure must conform to	
		product specification sheet.	

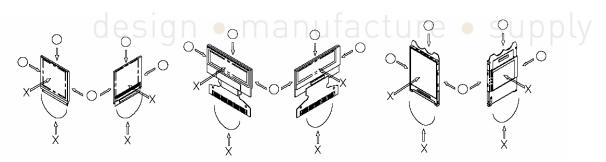
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No Display	Major	
Dark crisscross line	Major	
Short	Major	
Miss line	Major	
Wrong Display	Major	



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- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

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View Angle	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1			
Daarana Tira	T rise	_		10		μs
Response Time	T fall	_		10		μs
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50% CheckBoard Brightness		285mW(5V*57mA)				Note1
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